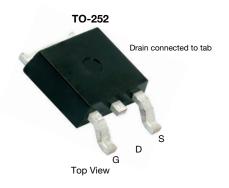
## SQD10950E

www.vishay.com

**Vishay Siliconix** 

# Automotive N-Channel 250 V (D-S) 175 °C MOSFET

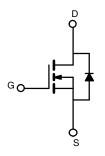


PRODUCT SUMMARY	
V <sub>DS</sub> (V)	250
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.1620
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = 7.5 V	0.1800
I <sub>D</sub> (A)	11.5
Configuration	Single
Package	TO-252

#### **FEATURES**

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 %  $R_{\rm q}$  and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> =	= 25 °C, unles	s otherwise noted	l)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	250	V
Gate-source voltage		V <sub>GS</sub>	± 20	v
Continuous drain current	T <sub>C</sub> = 25 °C	l-	11.5	
	T <sub>C</sub> = 125 °C	Ι <sub>D</sub>	6.6	
Continuous source current (diode conduction) <sup>a</sup>		I <sub>S</sub>	50	А
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	30	
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	10	
Single pulse avalanche energy	L = 0.1 mm	E <sub>AS</sub>	5	mJ
Maximum power dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	PD	62	W
	T <sub>C</sub> = 125 °C	ı.D	20	۷V
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	50	°C/W	
Junction-to-case (drain)		R <sub>thJC</sub>	2.4	C/ VV	

Notes

a. Package limited

b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

c. When mounted on 1" square PCB (FR4 material)

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**SQD10950E** 

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V

<b>SPECIFICATIONS</b> ( $T_C = 25 \text{ °C}$ , <b>PARAMETER</b>	SYMBOL		T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	STMBOL	163	ST CONDITIONS	IVIIIN.	ITP.		UNI
	N	N/	0.1/ 1 0500	050	1	1	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		250	-	-	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	-	$= V_{GS}, I_D = 250 \mu A$	2.5	3.0	3.5	
Gate-source leakage	I <sub>GSS</sub>		$= 0 \text{ V}, \text{ V}_{\text{GS}} = \pm 20 \text{ V}$	-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 250 V	-	-	1	μA
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 250 \text{ V}, \text{ T}_{\text{J}} = 125 ^{\circ}\text{C}$	-	-	50	<u> </u>
		$V_{GS} = 0 V$	V <sub>DS</sub> = 250 V, T <sub>J</sub> = 175 °C	-	-	250	μA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \geq 5 \ V$	12	-	-	A
		$V_{GS} = 10 V$	I <sub>D</sub> = 12 A	-	0.1342	0.1620	
Drain-source on-state resistance <sup>a</sup>	Р	$V_{GS} = 7.5 V$	I <sub>D</sub> = 10 A	-	0.1443	0.1800	
Drain-source on-state resistance -	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	$V_{\rm GS} = 10 \text{ V}$ $I_{\rm D} = 12 \text{ A}, T_{\rm J} = 125 \text{ °C}$		-	0.3437	Ω
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 12 A, T <sub>J</sub> = 175 °C	-	-	0.4560	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 12 A	-	12	-	S
Dynamic <sup>b</sup>		•			<u> </u>		
Input capacitance	C <sub>iss</sub>			-	558	785	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 25 V, f = 1 MHz	-	308	435	pF
Reverse transfer capacitance	C <sub>rss</sub>	1		-	11	16	
Total gate charge <sup>c</sup>	Qg			-	10.6	16	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>DS</sub> = 125 V, I <sub>D</sub> = 10 A	-	3.1	-	nC
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>	40		_	2.8	_	1
Gate resistance	R <sub>g</sub>		f = 1 MHz	1.9	3.8	5.7	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	8	20	
Rise time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 125 \text{ V}, \text{ R}_{\text{L}} = 12.5 \Omega$		-	3	10	
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>		$V_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega$	-	15	30	ns
Fall time c	t <sub>f</sub>	-	<u></u>	-	3	10	ĺ
Source-Drain Diode Ratings and Chara	· · ·				Ű	10	L
Pulsed current <sup>a</sup>	I <sub>SM</sub>			_	-	30	A
Forward voltage	V <sub>SD</sub>	I	= 15 A, V <sub>GS</sub> = 0 V		0.9	1.5	v
Body diode reverse recovery time		I F =	· · · · · · , v <sub>GS</sub> – · · v	-	127	260	ns
, ,	t <sub>rr</sub>	4					
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 10	A, di/dt = 100 A/µs	-	583	1170	nC
Reverse recovery fall time	t <sub>a</sub>	4		-	88	-	ns
Reverse recovery rise time	t <sub>b</sub>			-	39	-	<u> </u>
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-8.6	-	A

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

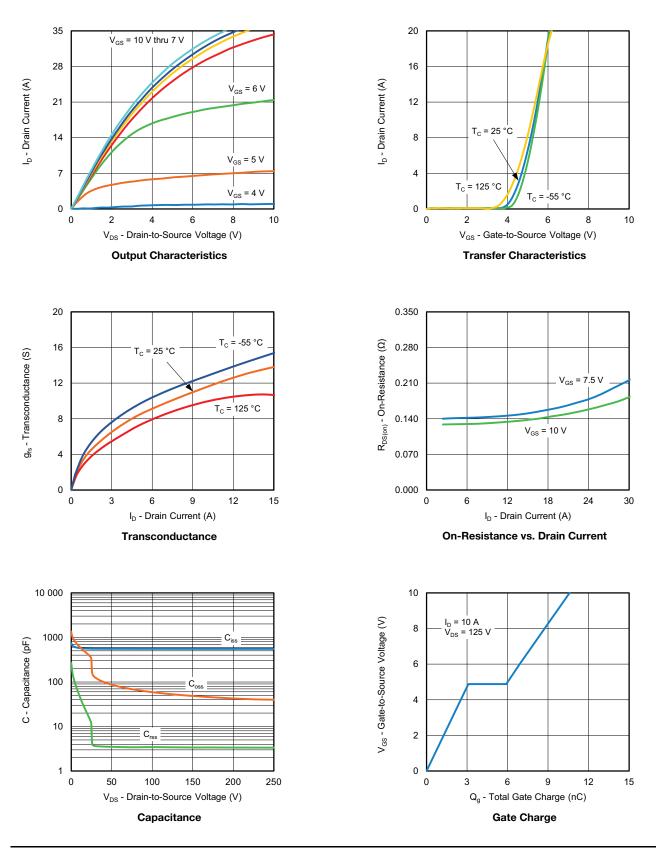
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



S19-0200-Rev. A, 04-Mar-2019

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# **SQD10950E**

Vishay Siliconix

### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)

100

10

1

0.1

0.01

0.6

0.2

-0.2

-0.6

-1.0

-14

100

10

1

0.1

0.01

0.01

Тc = 25 °C, sinale pulse

0.1

I<sub>D</sub> - Drain Current (A)

-50 -25 0 25 50 75 100

V<sub>GS(th)</sub> - Variance (V)

0

0.3

0.6

Source Drain Diode Forward Voltage

I<sub>s</sub> - Source Current (A)

T = 150 °C

T<sub>J</sub> = 25 °C

0.9 V<sub>SD</sub> - Source-to-Drain Voltage (V)

1.2

 $I_D = 5 \text{ mA}$ 

125 150 175

100 µs

1 ms

10 ms

100 ms, 1 s, 10 s, DC

1000

= 250 µA

I<sub>D</sub>

T<sub>J</sub> - Junction Temperature (°C)

**Threshold Voltage** 

Limited by R<sub>D</sub>

1

10

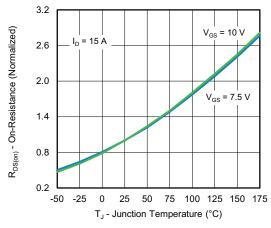
V<sub>DS</sub> - Drain-to-Source Voltage (V)

Safe Operating Area

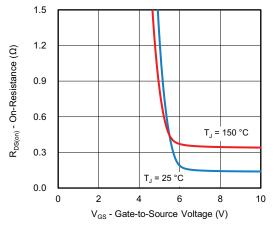
**BVDSS** limited

100

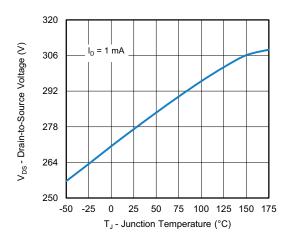
1.5



**On-Resistance vs. Junction Temperature** 



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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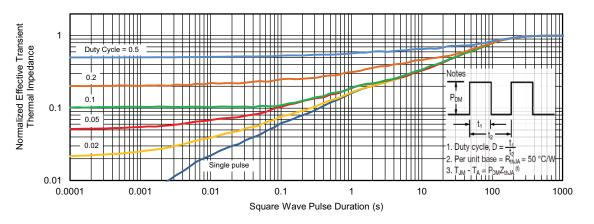
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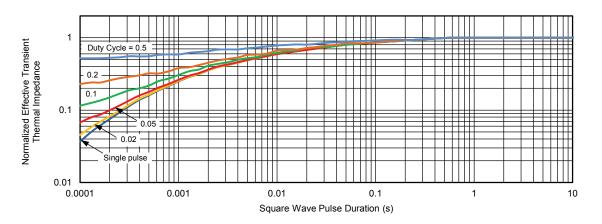
SQD10950E

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### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

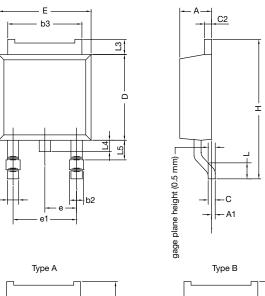
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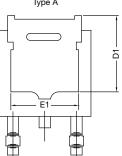
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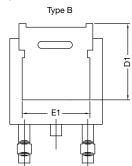


TO-252AA Case Outline





b



MIN.   2.18   -   0.64   0.76   4.95   0.46   0.46   5.97   4.10	MAX. 2.38 0.127 0.88 1.14 5.46 0.61 0.89 6.22	MIN. 0.086 - 0.025 0.030 0.195 0.018 0.018 0.235	MAX. 0.094 0.005 0.035 0.045 0.215 0.024 0.035 0.245	
- 0.64 0.76 4.95 0.46 0.46 5.97 0.64 0.65 0.65 0.65 0.65 0.65 0.65 0.65 0.65	0.127 0.88 1.14 5.46 0.61 0.89 6.22	- 0.025 0.030 0.195 0.018 0.018	0.005 0.035 0.045 0.215 0.024 0.035	
0.64   0.76   4.95   0.46   0.46   5.97	0.88 1.14 5.46 0.61 0.89 6.22	0.025 0.030 0.195 0.018 0.018	0.035 0.045 0.215 0.024 0.035	
0.76 4.95 0.46 0.46 5.97	1.14 5.46 0.61 0.89 6.22	0.030 0.195 0.018 0.018	0.045 0.215 0.024 0.035	
4.95 0.46 0.46 5.97	5.46 0.61 0.89 6.22	0.195 0.018 0.018	0.215 0.024 0.035	
0.46 0.46 5.97	0.61 0.89 6.22	0.018 0.018	0.024 0.035	
0.46 5.97	0.89 6.22	0.018	0.035	
5.97	6.22			
		0.235	0.245	
4.10			0.240	
	-	0.161	-	
6.35	6.73	0.250	0.265	
4.32	-	0.170	-	
9.40	10.41	0.370	0.410	
2.28 BSC		0.090 BSC		
4.56 BSC		0.180	BSC	
1.40	1.78	0.055	0.070	
0.89	1.27	0.035	0.050	
-	1.02	-	0.040	
1.01	1.52	0.040	0.060	
	4.32 9.40 2.28 B 4.56 B 1.40 0.89 -	4.32     -       9.40     10.41       2.28 BSC     4.56 BSC       1.40     1.78       0.89     1.27       -     1.02	4.32     -     0.170       9.40     10.41     0.370       2.28 BSC     0.090       4.56 BSC     0.180       1.40     1.78     0.055       0.89     1.27     0.035       -     1.02     -	

#### Notes

• Dimension L3 is for reference only

• Dimension D1 and E1 on type A and B is the same

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### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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